

RFGA2044

50MHz-3000MHz, InGap HBT MMIC Amplifier

Product Overview

The RFGA2044 is a high performance InGaP HBT MMIC amplifier. The RFGA2044's internal active bias circuitry allows the amplifier to operate directly from a 5V supply and provides stable current over temperature and process variations of the Beta. This Darlington amplifier is internally matched to 50Ω making it ideal for applications requiring small footprints and minimal external components.

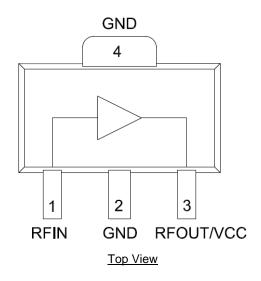


SOT-89 Package

Key Features

- Low Cost
- · Broadband Gain
- Internally Matched
- Internal Active Bias
- No Dropping Resistor Required
- Single Supply 5V Operation
- HBM ESD Level >1000V

Functional Block Diagram



Applications

- PA Driver Amplifier
- LO Buffer Amplifier
- Cellular, PCS, GSM, UMTS, LTE, TD_SCDMA
- Wideband Instrumentation
- Wireless Data, Satellite Terminals

Ordering Information

Part No.	Description
RFGA2044TR13	2,500 pieces on a 13" reel
RFGA2044 PCK-410	500-3000 MHz Evaluation Board with a 5-piece sample bag

RFGA2044 50MHz-3000MHz, InGap HBT MMIC Amplifier

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	−55 to +150 °C
Device Voltage (Vcc)	+6.0 V
Device Current (Icc)	130 mA
RF Input Power, CW, 2:1 Output VSWR	+20 dBm
RF Input Power, CW, 10:1 Output VSWR	+15 dBm
Junction Temperature (T _J)	+150 °C

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

Parameter	Min	Тур	Max	Units
Device Voltage (Vcc)		+5	+5.25	V
TCASE	-40		+85	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

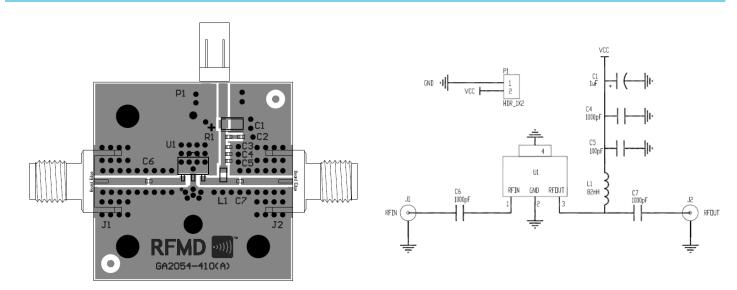
Parameter Conditions (1)		Min	Тур	Max	Units
Linear Operation	Standard EVB circuit without R2				
Input Power	V _{CC} < 5.0V, Load VSWR< 2:1, R2 Open			6.0	dBm
	850 MHz		15.3		dB
Gain, Small Signal	2140 MHz	13.5	15.1	16.5	dB
	2650 MHz		15.1		dB
Input Return Loss	2140 MHz		15.0		dB
Output Return Loss	2140 MHZ		140		dB
	850 MHz		19.0		dBm
Output P1dB	2140 MHz	17.3	18.8		dBm
	2650 MHz		18.2		dBm
	850 MHz		35.5		dBm
Output IP3 (2)	2140 MHz	28.0	30.5		dBm
	2650 MHz		29.0		dBm
Bandwidth	Minimum 10 dB typical return loss		3000		MHz
Reverse Isolation	2140 MHz		19.0		dB
Noise Figure	2 140 MHZ		4.3		dB
Device Quiescent Current, Icq	Pin 3		68	78	mA
Thermal Resistance, θ_{jc}	Junction to case at quiescent state no RF		135		°C/W
Saturated Operation	With R2 5.1KΩ Pin 1 and GND lowering I _{CQ}				
Input Power	V _{CC} < 5.0V, Load VSWR< 2:1, R2=5.1 KΩ			14	dBm
Saturated Output Power	850 MHz		19.4		dBm
	2140 MHz		19.8		dBm
	2650 MHz		19.8		dBm
Operating Current, Icc				90	mA

Notes

- 1. Test conditions unless otherwise noted: V_{CC} = +5.0 V, Temp = +25 °C, 50 Ω test system
- 2. $P_{OUT} = 0$ dBm/tone, $\Delta f = 1$ MHz



500MHz to 3500 MHz Evaluation Board - RFGA2044PCK-410



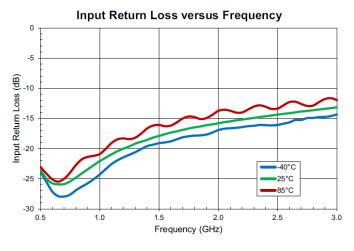
Bill of Material - RFGA2044PCK-410

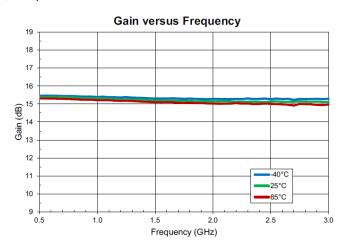
Reference Des.	Value	Description	Manuf.	Part Number
PCB	-	Printed Circuit Board	Qorvo	-
U1	-	AMP, InGaP Darlington HBT, SOT-89	AMP, InGaP Darlington HBT, SOT-89 Qorvo RFGA20	
C1	1 µF	CAP, 1 µF, 20%, 25V, TANT-A	AVX	TAJA105M025
C4, C6, C7	1000 pF	CAP, 1000 pF, 10%, 50V, X7R, 0402	Taiyo Yuden	RM UMK105BJ102KV-F
C5	100 pF	CAP, 100 pF, 5%, 50V. C0G, 0402	Taiyo Yuden	RM UMK105CG101JV-F
L1	82 nH	IND, 82 nH, 10%, W/W, 0805	Coilcraft	0805CS-820XKBC
J1, J2	-	CONN, SMA, END LNCH, FLT, 0.062"	Johnson	142-0701-821
P1	-	CONN, HDR, ST, PLRZD, 2-Pin, 0.100"	ITW Pancon	MPSS100-2-C

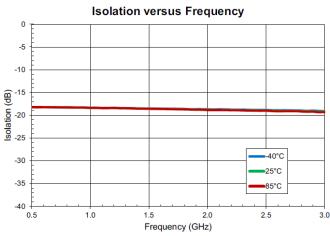


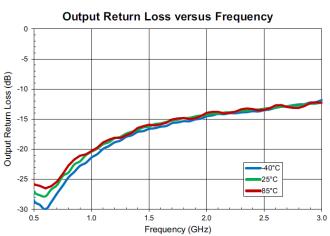
Linear Operation Performance Plots – RFGA2044PCK-410

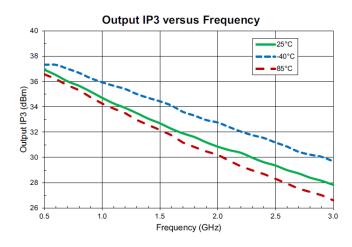
Test conditions unless otherwise noted: $V_{CC} = +5V$, 50Ω test system, Temp.=+25 °C

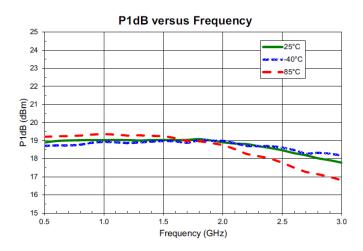








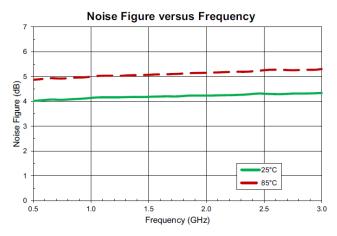


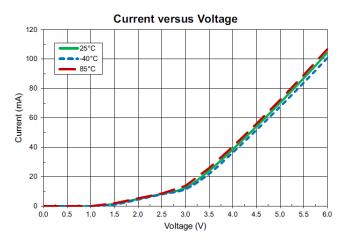


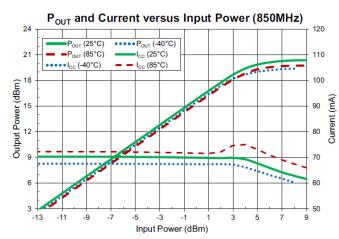


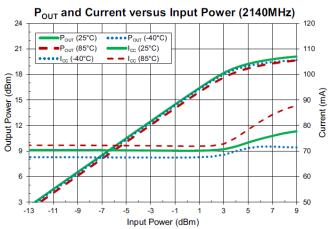
Linear Operation Performance Plots – RFGA2044PCK-410 (continued)

Test conditions unless otherwise noted: $V_{CC} = +5V$, 50Ω test system, Temp.=+25 °C

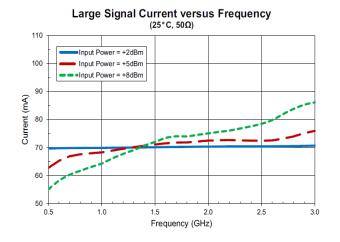






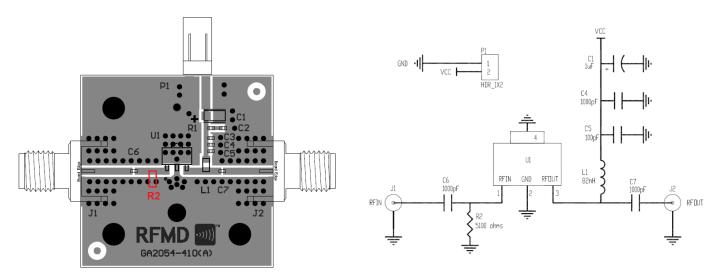








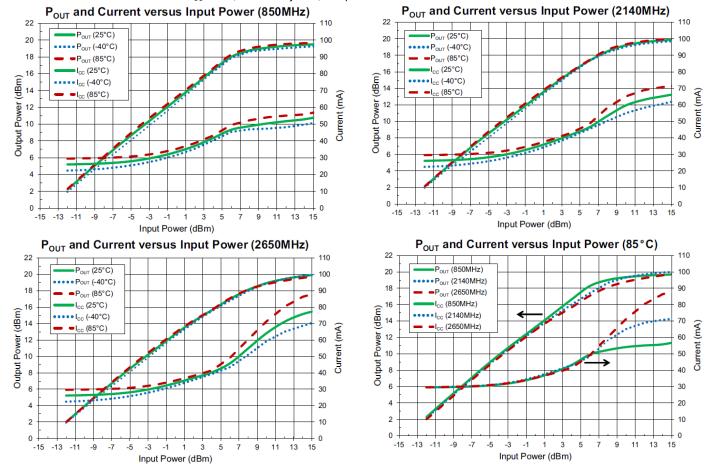
Saturated Application Board and Schematic



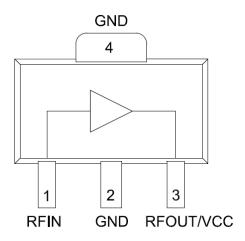
Additional resistor R2, $5.1K\Omega$, shunted to ground in between C6 and Pin 1

Saturated Performance Plots – with R2, $5.1K\Omega$

est conditions unless otherwise noted: $V_{CC} = +5V$, 50Ω test system, Temp.=+25 °C



Pad Configuration and Description



Top View

Pad No.	Label	Description
1	RFIN	RF input. External DC Block capacitor required.
3	RFOUT/VCC	RF output and DC Supply input. Device Collector, External DC Block capacitor required.
2, 4 Backside Paddle	GND	RF and DC ground. Use recommended via hole pattern to minimize inductance and thermal resistance. See PCB Mounting Pattern for suggested footprint.

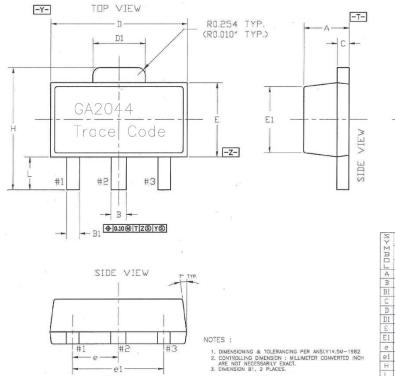
BOTTOM VIEW



Package Marking and Dimensions

Marking: Part Number - GA2044

Trace Code - Assigned by sub-contractor



	#3		#2		#1	1
NYEMOJ			Com	mon		
MB	DIMENSI	ONS MILL	IMETER	DIME	NSIONS	INCH
	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
A	1.40	1.50	1.60	0.055	0.059	0.063
В	0.44	0.50	0.56	0.017	0.020	0.022
B1	0.36	0.42	0.48	0.014	0.017	0.019
C	0.35	0.40	0.44	0.014	0.016	0.017
-		1	-	The second second second	Mindred College Service	The state of the state of the state of

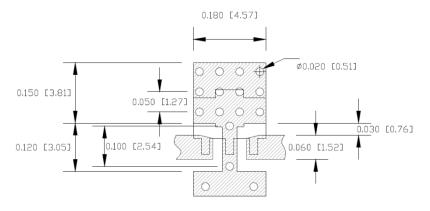
	D	4.40	4,50	
	D1	1.62	1.73	
	E	2.30	2.50	
	E1	2.13	2.20	1
	е	1.	50 BSC	
H	е1	3.	OO BSC	
	1.1	205	1 410	1

4.60 0.173 0.177 0.181 1.83 0.064 0.068 0.072 2.60 0.091 0.098 0.102 e1 3.00 BSC. 0.118 BSC. H 3.95 4.10 4.25 0.156 0.161 0.167 L 0.90 1.10 1.20 0.035 0.043 0.047

Notes:

- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.

PCB Mounting Pattern



- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. Use 1 oz. copper minimum for top and bottom layer metal.
- Via holes are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation. We recommend a 0.35mm (#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of 0.25 mm (0.01").
- 4. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.



Tape and Reel Information – Carrier and Cover Tape Dimensions

User Direction of Feed Cover Tape See Note 6 2.0 ±0.05 0.30 ±0.05-4.0 See Note 1 _1.75 ±.1 R0.3 MAX-5.5 9.2 ±0.2 12.0 ±0.3 1.9 ±0.2 4.6 ±0.2 See Note 4 -8.0 ±0.2 Ø1.5 MIN-R0.3 Typical SECTION A-A

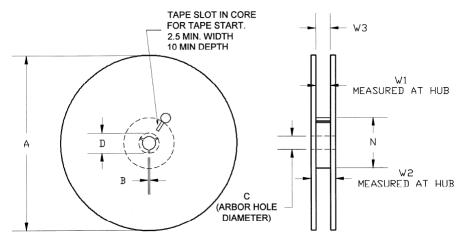
- 1. 10 sprocket hole pitch cumulative tolerance
 2. Camber not to exceed Imm in 100mm
 3. Material: Black Conductive Polystyrene
 4. Measured on a plane 0.3mm above the bottom of the pocket.
 5. Measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
 6. Material: Antistatic Polyester Film

Feature	Measure	Symbol	Size (in)	Size (mm)
	Length	A0	0.181	4.60
Covity	Width	B0	0.193	4.90
Cavity	Depth	K0	0.075	1.90
	Pitch	P1	0.315	8.00
Centerline Distance	Cavity to Perforation - Length Direction	P2	0.079	2.00
Centenine Distance	Cavity to Perforation - Width Direction	F	0.217	5.50
Cover Tape	Width	С	0.362	9.20
Carrier Tape	Width	W	0.472	12.0



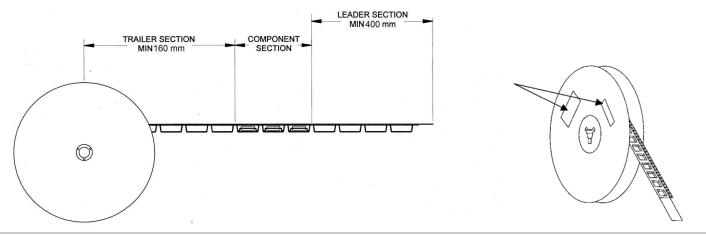
Tape and Reel Information – Reel Dimensions

Standard T/R size = 2,500 pieces on a 13" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
	Diameter	Α	12.992	330.0
Flange	Thickness	W2	0.717	18.2
	Space Between Flange	W1	0.504	12.8
	Outer Diameter	N	4.016	102.0
Llook	Arbor Hole Diameter	С	0.512	13.0
Hub	Key Slit Width	В	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

Tape and Reel Information - Tape Length and Label Placement



Notes

- 1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
- 2. Labels are placed on the flange opposite the sprockets in the carrier tape.

Handling Precautions

Parameter	Rating	Standard
ESD-Human Body Model (HBM)	Class 1C	ESDA / JEDEC JS-001-2012
ESD-Charged Device Model (CDM)	Class C3	ESDA / JEDEC JS-002-2012
MSL-Moisture Sensitivity Level	Level 3	IPC/JEDEC J-STD-020



Caution! **ESD-Sensitive Device**

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

Contact plating: NiPdAu

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- **PFOS Free**
- **SVHC Free**



Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com Tel: 1-844-890-8163

Email: customer.support@gorvo.com

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